## MOSFET – Power, Single N-Channel 60 V, 2.5 mΩ, 155 A

#### Features

- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Q<sub>G</sub> and Capacitance to Minimize Driver Losses

MAXIMUM RATINGS (T<sub>.1</sub> = 25°C unless otherwise noted)

- AEC–Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant



### **ON Semiconductor®**

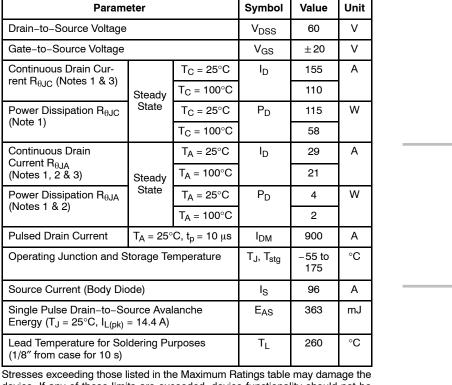
#### www.onsemi.com

V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub>	I <sub>D</sub>
60 V	2.5 mΩ @ 10 V	155 A
	3.4 mΩ @ 4.5 V	100 A

DO

**N-CHANNEL MOSFET** 

G



Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

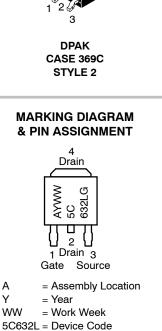
#### THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case (Drain) (Note 1)	$R_{\theta JC}$	1.3	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	37	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm<sup>2</sup>, 2 oz. Cu pad.

3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.



G = Pb-Free Package

#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

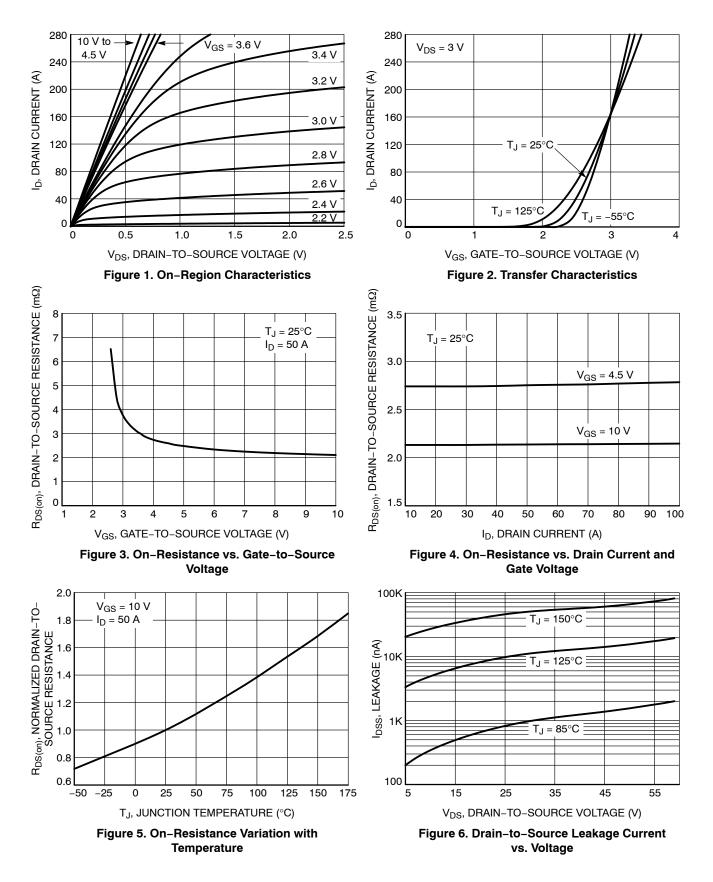
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## **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = 25°C unless otherwise noted)

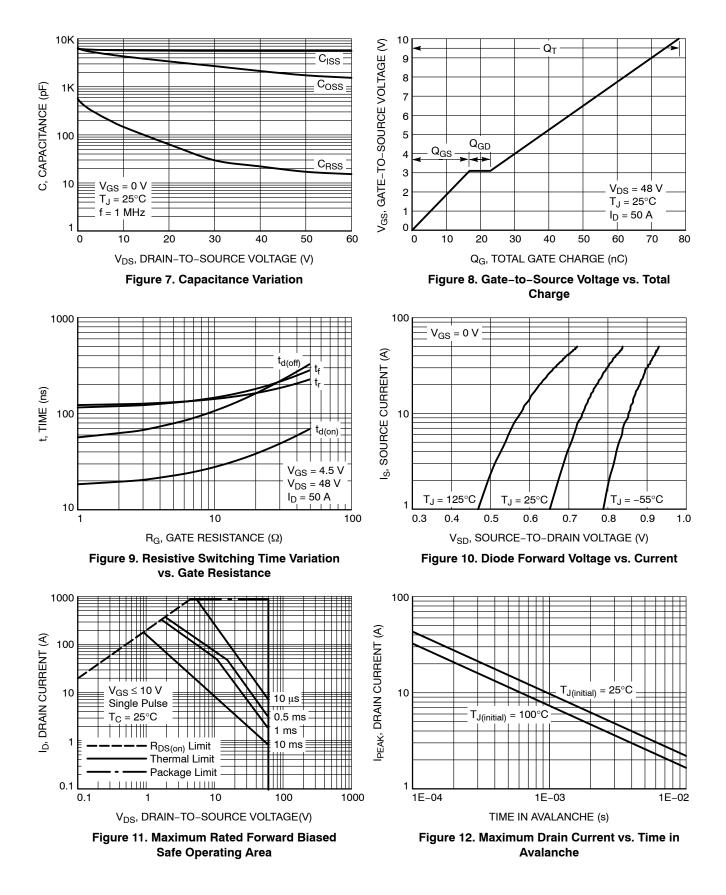
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ = 0 V, I <sub>D</sub> =	= 250 μA	60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> /T <sub>J</sub>				24		mV/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 60 V	T <sub>J</sub> = 25°C T <sub>J</sub> = 125°C			10 250	μΑ
Gate-to-Source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>G</sub>	-			100	nA
ON CHARACTERISTICS (Note 4)	'GSS	•DS = 0 •, •G	5 - 20 V			100	10.4
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub>	= 250 uA	1.2	1	2.1	V
Negative Threshold Temperature Coefficient	V <sub>GS(TH)</sub> /T <sub>J</sub>	- 43 - 53, 5			5.8		mV/°C
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 50 A			2.1	2.5	mΩ
	( )	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 50 \text{ A}$			2.7	3.4	-
Forward Transconductance	9 <sub>FS</sub>	V <sub>DS</sub> = 3 V, I <sub>D</sub>	= 50 A		185		S
CHARGES, CAPACITANCES AND GATE RE	SISTANCES				•		
Input Capacitance	C <sub>iss</sub>				5700		pF
Output Capacitance	C <sub>oss</sub>	V <sub>GS</sub> = 0 V, f = V <sub>DS</sub> = 25	1.0 MHz, 5 V		2800		1
Reverse Transfer Capacitance	C <sub>rss</sub>	$v_{\rm DS} = 25 v$			36		1
Total Gate Charge	Q <sub>G(TOT)</sub>	V <sub>DS</sub> = 48 V, I <sub>D</sub> = 50 A	V <sub>GS</sub> = 4.5 V		34		nC
			V <sub>GS</sub> = 10 V		78		1
Total Gate Charge	Q <sub>G(TOT)</sub>	V <sub>GS</sub> = 4.5 V, V <sub>DS</sub> = 48 V, I <sub>D</sub> = 50 A			34.0		nC
Threshold Gate Charge	Q <sub>G(TH)</sub>				9.5		]
Gate-to-Source Charge	Q <sub>GS</sub>				16.8		1
Gate-to-Drain Charge	Q <sub>GD</sub>	D			6.1		1
Plateau Voltage	V <sub>GP</sub>				3.1		V
Gate Resistance	R <sub>G</sub>				0.7		Ω
SWITCHING CHARACTERISTICS (Note 5)							
Turn-On Delay Time	t <sub>d(on)</sub>				20		ns
Rise Time	t <sub>r</sub>	V <sub>GS</sub> = 4.5 V, V <sub>E</sub>	<sub>DS</sub> = 48 V,		126		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_{\rm D} = 50 \text{ A}, \text{ R}_{\rm G} = 2.5 \Omega$			65		
Fall Time	t <sub>f</sub>				121		
DRAIN-SOURCE DIODE CHARACTERISTIC	S						
Forward Diode Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 50 A	$T_J = 25^{\circ}C$		0.8	1.2	V
			T <sub>J</sub> = 125°C		0.7		
Reverse Recovery Time	t <sub>RR</sub>	$V_{GS}$ = 0 V, dls/dt = 100 A/µs, $I_S$ = 50 A			71		ns
Charge Time	ta				36		
Discharge Time	tb				36		
Reverse Recovery Charge	Q <sub>RR</sub>				110		nC

 $\begin{array}{l} \mbox{4. Pulse Test: Pulse Width $\le$ 300 $\mu$s, Duty Cycle $\le$ 2\%$.} \\ \mbox{5. Switching characteristics are independent of operating junction temperatures.} \\ \end{array}$ 

#### **TYPICAL CHARACTERISTICS**



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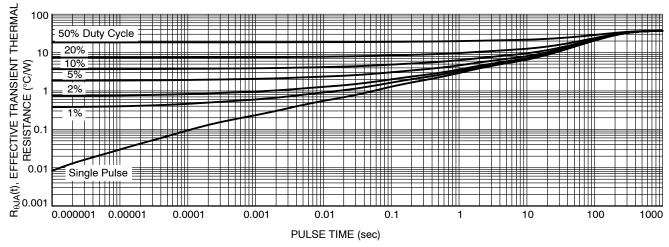


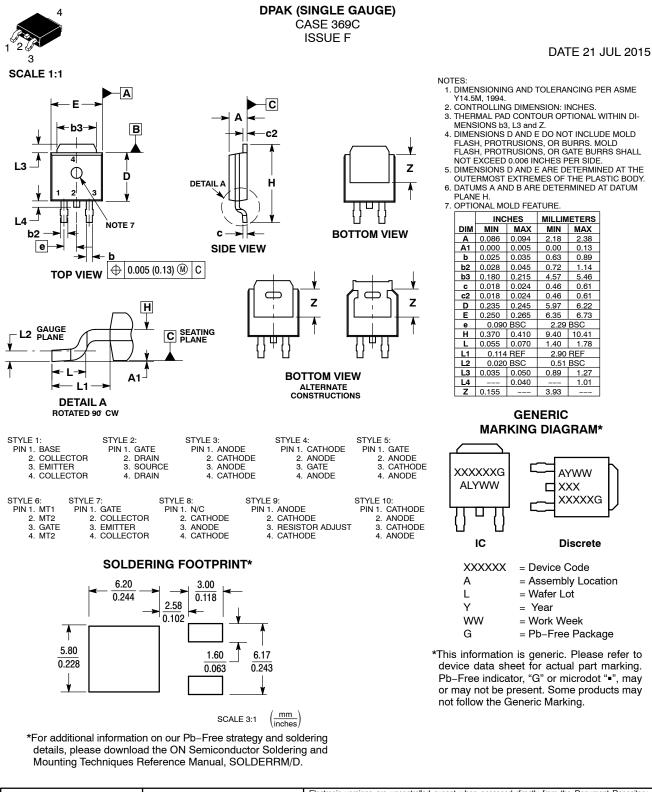
Figure 13. Thermal Response

#### **ORDERING INFORMATION**

Order Number	Package	Shipping <sup>†</sup>		
NVD5C632NLT4G	DPAK (Pb–Free)	2500 / Tape & Reel		

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# ONSEM<sup>1</sup>.



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